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The AEROVOX Research Worker

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Printed Electronic Circuits

By the Engineering Department, Aerovox Corporation

THE reproduction of electrical circuits on insulated surfaces by various printing techniques has become a standard method of fabricating small, lightweight, economical electronic devices. The increased emphasis placed by the Armed Services and industry on miniaturization and ruggedness of electrical components has caused this innovation to assume vital importance. Printed circuitry is no longer confined to a few military devices and hearing aids, but may now be encountered in a large number of everyday equipments. These include speech amplifiers, portable receivers, citizens two-way radios, television receiver front-ends, FM receivers, and many others. For this reason, a working knowledge of the design, production, and maintenance of such circuits will be a valuable asset to any worker in the electronics field. This issue of the AEROVOX RESEARCH WORKER is concerned with a discussion of the general types of printed circuits, the relative advantages of each, and methods of effecting servicing repairs.

The use of printed circuitry has been revolutionary not only because it permits the fabrication of extremely small and rugged electronic components, but also because it reduces the production of such components to a simple, rapid operation which

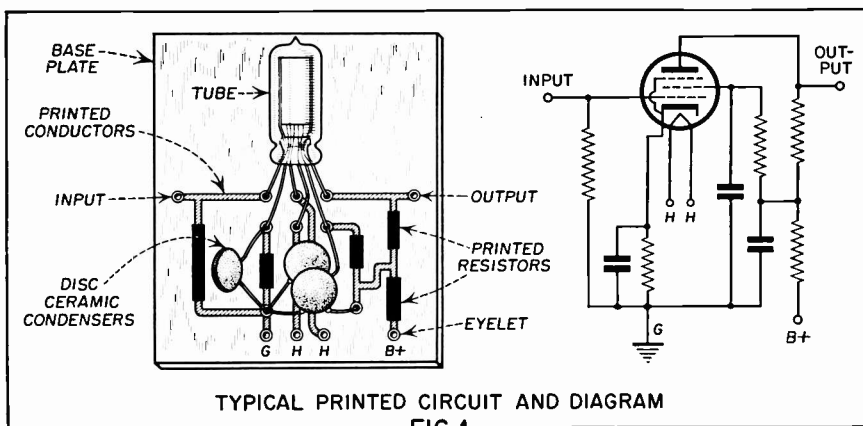
is almost completely devoid of the possibility of human error. By this method, a relatively unskilled operator can reproduce literally hundreds of complex units in the time formerly required to make one unit by old-fashioned "wire-by-wire" soldering techniques. In addition to electrical conductors, critical circuit components such as resistors, capacitors, and inductors can be "printed" into the circuit in the same operation and held to close, reproducible tolerances. Fig. 1 shows a typical printed circuit and its schematic diagram.

Printed circuits are classified according to the method used to repro-

duce them. There are, at present, six general types. These processes are: painting, spraying, vacuum evaporation, chemical processing, metal stamping, and powdered metal dusting. Each of these general categories will now be discussed in some detail.

Printing Techniques

Probably the most widely used process for producing printed circuits is the *painting* technique. In this method, the conductors and other components of the circuit being fabricated are painted on the insulating surface which acts as the base for the circuit. The paint may be applied by hand



TYPICAL PRINTED CIRCUIT AND DIAGRAM

FIG.1

AEROVOX PRODUCTS ARE BUILT BETTER

with a brush, although in production operations the silk-screen stenciling process is more frequently used. Thin ceramic or plastic sheets may be employed for the base, or a metallic surface covered with an insulating lacquer may be used. In special instances, the glass envelope of a vacuum tube has been utilized as a base for its associated printed circuit. See Fig. 2.

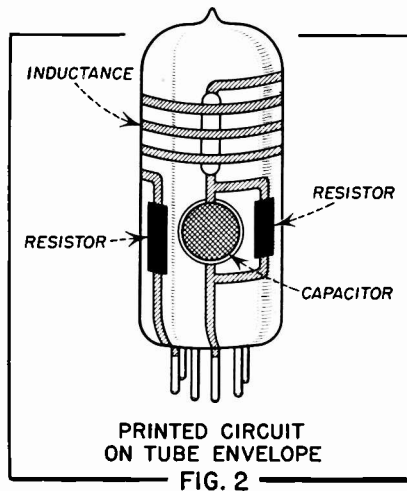
The paint used for electrical conductors consists of a powdered metal such as copper or silver in suspension in a liquid binder. This conducting paint is applied to the surface of the insulating base to form the "wires" of the circuit. Other paint, made up of a resistive material such as carbon, may be applied in specific amounts to form resistors. Capacitors may be made by printing the plates on opposite sides of the base plate, if the required capacitance is small. Otherwise, small capacitors (such as the AEROVOX Hi-Q BFD type disc ceramic) are connected to the printed circuit as in Fig. 3. It is interesting to note that these capacitors are manufactured by processes which are essentially printed circuit techniques. Inductances are produced by painting spirals of conducting paint on the surface of the ceramic or other base material. "Cross-overs" in the wiring are made by painting one conductor directly over the other with a layer of insulating material such as lacquer between, or by "detouring" one conductor to the other side of the plate for a short distance by means of metal rivets or eyelets through the insulator, as is illustrated in Fig. 4.

When all printed components have been painted in place, the entire assembly is "fired" at an elevated temperature to fuse the metal particles together and bond the circuit to the base plate. Temperatures ranging from room temperature for plastic bases to as high as 800 degrees C. for ceramics are used.

Vacuum tubes, external leads, and other components not printed are soldered to eyelets in the base plate as in Figs. 1 and 3. To take maximum advantage of the space-saving properties of printed circuits, tubes of the subminiature type are usually employed.

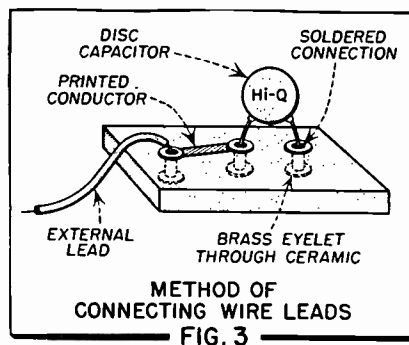
The painting technique has the advantage of requiring a minimum of auxiliary equipment and so has been the most popular type for experimentation and design work with printed circuits. It is also the best method to use in making repairs on printed circuits, as will be discussed later.

The *spraying* method of reproducing printed circuits differs from the painting technique in that the con-



ductors are sprayed onto the surface of the base. Both molten metals and metallic conducting paints may be applied in this manner. In some processes, stencils are used to define the circuit conductors. In others, grooves are machined or molded in the base material where a conductor or other circuit component is desired. Grooves may also be formed by sand-blasting through a stencil. Metal is then sprayed over the entire base plate, filling the grooves and covering the spaces between. The surface is then milled off, removing the excess metal and leaving only that in the grooves. High conductivity is obtained by this method since relatively large conductors are formed in the grooves. Standard tube sockets and other components are sometimes connected to sprayed circuits by mounting them on the opposite side of the base plate so that the terminals protrude through holes into the grooves. Then, when the circuit is sprayed, connections are automatically made to the conductors. Circuit cross-overs are made in a manner similar to that employed in the painting process. Resistors, capacitors, and inductances may also be formed by spraying.

The *vacuum evaporation* process of circuit printing consists of evaporating a metal such as silver, copper, or nickel onto the surface of the dielectric material by melting the metal in



a vacuum. A mask or stencil on the surface of the insulator is used to outline the circuit desired. In one such process, called "cathode sputtering", a high voltage is applied between the source of metal vapor (the cathode) and the work upon which it is to be deposited (the anode). The metal vapor is thus drawn to the work by electrostatic forces. Only a "rough" vacuum, such as can be produced by a good mechanical vacuum pump, is required for this process.

Another vacuum process used is very similar to cathode sputtering except that no voltage is applied between the cathode and the work. Metal evaporated from a heated filament, or other source of metal vapor, is distilled on the printed circuit plate placed over it. In either type of vacuum processing, it is unnecessary to further heat treat or fire the deposited metal. Only thin films are usually deposited in this manner. If greater conductivity is required, conductors may be built up by electroplating.

In the *chemical-deposition* methods of making printed circuits, the techniques employed are similar to those used in silvering mirrors. A silvering solution, consisting of ammonia and silver nitrate mixed with a reducing agent, is poured on the chemically clean surface to be coated. The confines of the solution are controlled by an adhesive stencil. The metal films obtained are usually too thin to permit direct soldering, but may be built up by repeated coatings or by plating. The chemical processes have not been applied as extensively as those discussed above.

The *metal stamping* technique has been used principally to print loop antennas on the back covers of radio receivers. However, other types of circuit wiring have been produced by this method. A die, bearing the outline of the desired circuit, is used to press a thin metal foil into the surface of a plastic or other insulator. In the same operation the sharp edges of the die cut the metal sheet to the desired shape. The metal sheet may be backed by an adhesive to insure a good bond. Circuits made in this manner have good conductivity.

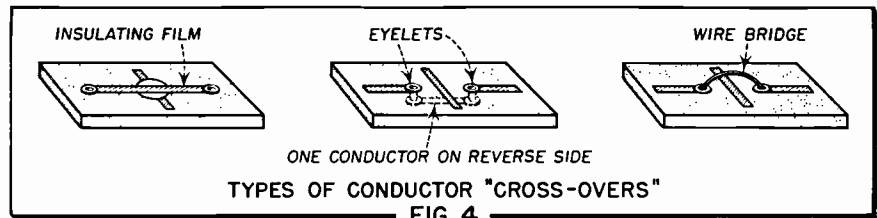
The last general type of printed circuit is produced by a process known as "dusting". In this method, a powdered metal is dusted onto the insulating base plate and fired in place. The circuit outline is defined either by coating the entire insulator with a sticky substance and applying the metal powder through a stencil, or by applying the bonding substance through the stencil and then dusting on the powder so that it is held in place by the adhesive until fired.



Servicing Printed Circuits

As was mentioned above, the most convenient method of making repairs and replacements in printed circuits is the brush-applied painting technique. Kits of such paints, including both conductor and resistor mixtures, are commercially available. Most of these paints require no heat for drying, so that they may be used for repairing circuits having parts which cannot be subjected to high temperatures. This is an important precaution when working with circuits printed on certain types of plastic.

Although subminiature tube sockets are sometimes used with printed circuits, tubes are frequently connected directly to metal eyelets in the base plate, as in Fig. 1. When replacing tubes connected in this manner, care must be exercised to avoid the use of excessive heat during soldering operations. Soldered connections may also be made directly to printed conductors if the base material will stand the heat involved. A solder containing a small percentage of silver should be used for best results. Where soldering is inadvisable, connections to tube



leads and other wires should be made with metallic paint.

Printed resistors which have become defective may be repaired or replaced by the painting technique. Defective resistors are located in the usual manner with an ohmmeter. If it becomes necessary to "disconnect" a printed resistor from the circuit for a resistance check, this may be accomplished by scratching through the printed conductor lead with a sharp instrument. If defective, the resistor may be repaired with resistive paint. It will usually be found to be open or high in value. In such cases, additional resistive paint should be applied over the old resistor to reduce its resistance to the proper value. Some commercial printed circuits

have a protective layer of lacquer over the conductors and particularly over resistors to prevent moisture absorption. This coating must be completely removed before repairing resistors. If attempts to repair defective resistors are unsuccessful, the old coating should be removed completely and a new resistor painted in its place. The proper dimensions may be determined by trial and error, keeping in mind that the resistance is directly proportional to the length, and inversely proportional to width and thickness. The resistance material must make good contact with the printed conductors at the ends. Breaks introduced in the conductors to isolate resistors may be repaired with a bridge of conducting paint.

Field Strength Meter Modifications

Much interest has been evidenced in the portable TV field strength meter described in the January RESEARCH WORKER. Many readers, however, have reported difficulty in obtaining either the RK61 or RK62 gas-triode tubes recommended for use as the superregenerative i.f. and second detector stage in this instrument. Information from the tube manufacturer indicates that the RK62 was discontinued some time ago in favor of the smaller RK61, and that this type has been temporarily forced out of production due to high priority military requirements. It is anticipated that manufacture of this type will be resumed soon.

Although there is no direct substitute which will give the same very high gain and positive action of these gas triodes in this application, it has been found that a high-vacuum triode can be made to give almost equivalent results if used in conjunction with an indicating meter of higher sensitivity.

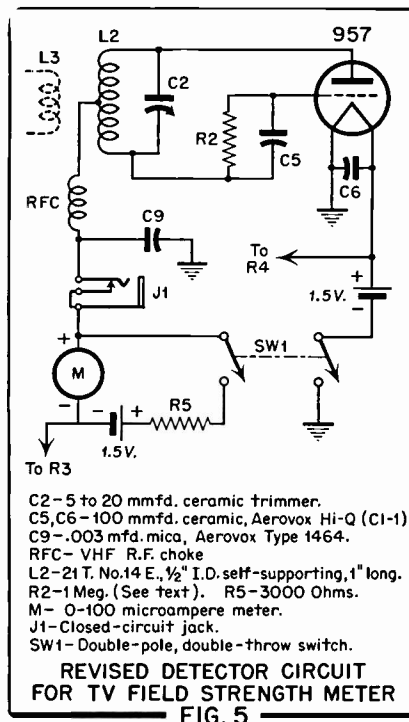
Fig. 5 shows the modified circuit of this stage of the field strength meter. The local oscillator stage and the crystal mixer remain as shown in the January issue. The gas tube is replaced by a 957 "acorn" triode like that used as the tunable local oscillator, and the 0-1 ma. meter is re-

placed by one having a full scale deflection of not more than 100 microamperes. If such a meter is not available for mounting in the instrument, an external high sensitivity meter, as

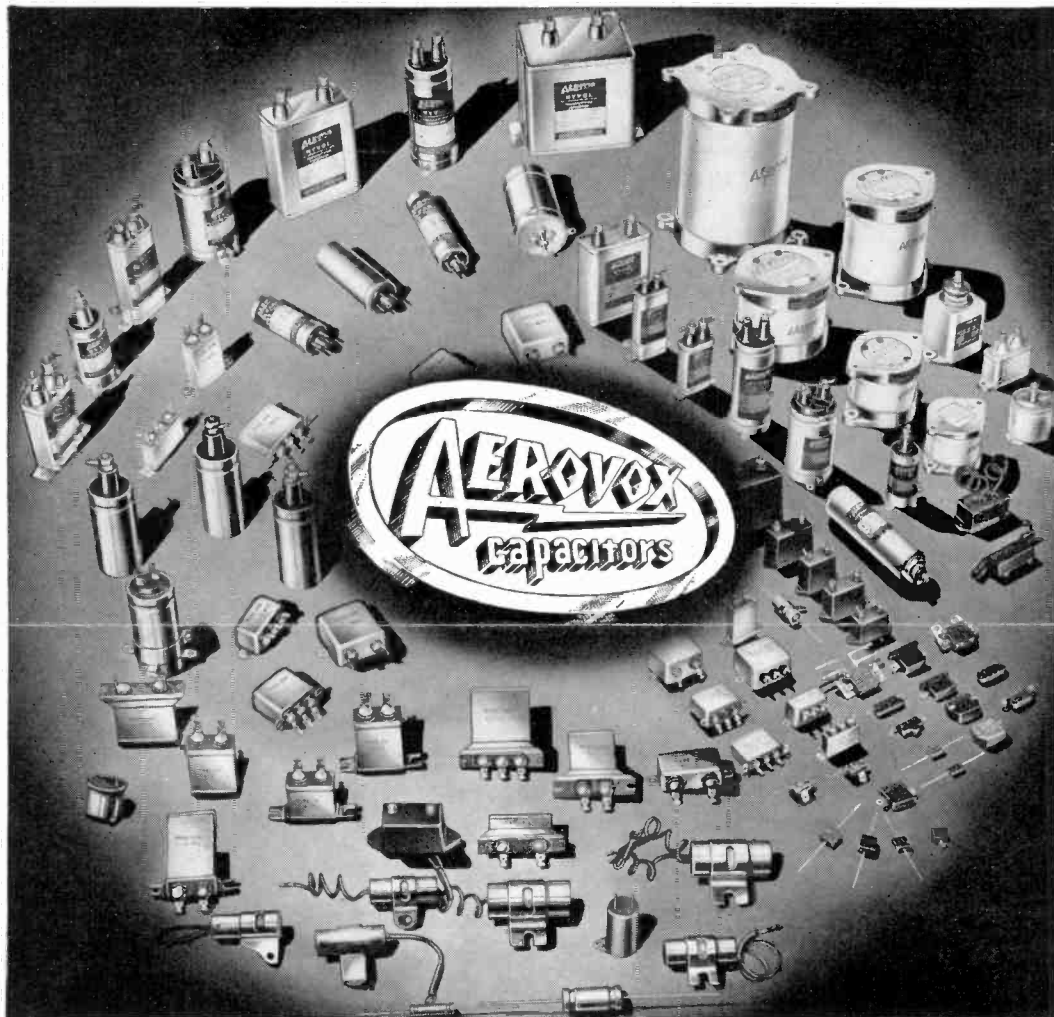
is used in most multi-meters, may be used.

The 957 triode circuit is somewhat more difficult to adjust for maximum sensitivity. The value of the bias resistor (R2) is critical and several values around one megohm should be tried to determine which gives the maximum plate current change when a signal is received. The coupling between L2 and L3 also has a direct effect on the amount of meter deflection obtained. The hard tube (957) seems to require slightly tighter coupling than was required by the gas triode. A plate current swing of 50-75 microamperes should be obtainable when these adjustments have been optimized.

Because of the more delicate meter employed in this circuit, care must be exercised to protect it from excessive current surges due to failure of the "bucking" voltage applied through R5. SW2 should always be closed first and R3 then adjusted to a predetermined setting at which the tube draws about 500 microamperes. When SW1 is closed, plate current flows but is cancelled by the "bucking" current, giving a reading of nearly zero on the meter. R3 may then be given a final adjustment to zero the meter. A TV signal should then give an upward deflection.



- C2 - 5 to 20 mmfd. ceramic trimmer.
- C5, C6 - 100 mmfd. ceramic, Aerovox Hi-Q (Cl-1)
- C9 - .003 mfd. mica, Aerovox Type 1464.
- RFC - VHF R.F. choke
- L2 - 21 T. No. 14 E., 1/2" I.D. self-supporting, 1" long.
- R2 - 1 Meg. (See text). R5 - 3000 Ohms.
- M - 0-100 microampere meter.
- J1 - Closed-circuit jack.
- SW1 - Double-pole, double-throw switch.



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